

# PHOTOCOUPLER PS9313L,PS9313L2

# 1 Mbps, OPEN COLLECTOR OUTPUT TYPE, HIGH CMR, INTELLIGENT POWER MODULE DRIVE -NEI 8 mm CREEPAGE 6-PIN SDIP PHOTOCOUPLER

-NEPOC Series-

#### DESCRIPTION

The PS9313L and PS9313L2 are optical coupled isolators containing a GaAlAs LED on the input side and a photo diode and a signal processing circuit on the output side on one chip.

The PS9313L and PS9313L2 are specified high CMR, high CTR and pulse width distortion with operating temperature. It is suitable for IPM drive.

The PS9313L is lead bending type (Gull-wing) for surface mounting.

The PS9313L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

#### FEATURES

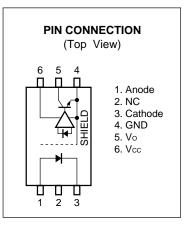
- High common mode transient immunity (CMH, CML =  $\pm 15 \text{ kV}/\mu \text{s}$  MIN.)
- Half size of 8-pin DIP
- Long creepage distance (8 mm MIN. : PS9313L2)
- High-speed response (tPHL = 500 ns MAX., tPLH = 750 ns MAX.)
- Maximum propagation delays (tplh tphL = 220 ns TYP.)
- Pulse width distortion ( $|t_{PHL} t_{PLH}| = 220 \text{ ns TYP.}$ )
- High isolation voltage (BV = 5 000 Vr.m.s.)
- · Open collector output
- Pb-Free product
- Safety standards
  - UL approved: No. E72422
  - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
  - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40024069 (Option)

#### **APPLICATIONS**

IPM Driver

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General purpose inverter



#### TRUTH TABLE

LED	Output
ON	L
OFF	н

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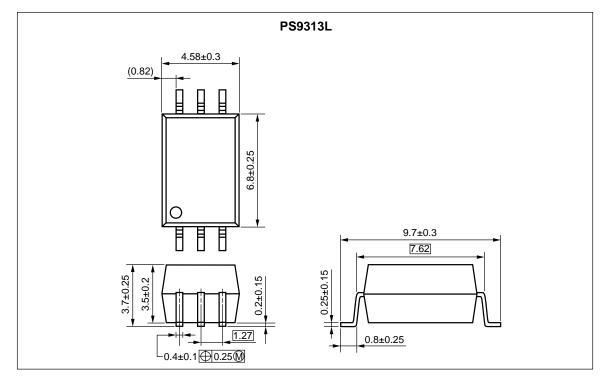
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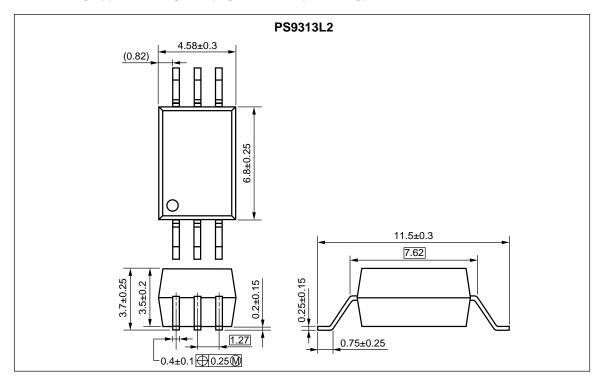
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

## PACKAGE DIMENSIONS (UNIT: mm)

## Lead Bending Type (Gull-wing) For Surface Mount

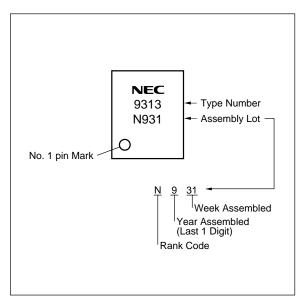


Lead Bending Type For Long Creepage Distance (Gull-wing) For Surface Mount



2

#### <R> MARKING EXAMPLE



## PHOTOCOUPLER CONSTRUCTION

Parameter	PS9313L	PS9313L2	
Air Distance (MIN.)	7 mm	8 mm	
Outer Creepage Distance (MIN.)	7 mm	8 mm	
Isolation Distance (MIN.)	0.4 mm	0.4 mm	

## ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS9313L	PS9313L-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9313L
PS9313L-E3	PS9313L-E3-AX	(Ni/Pd/Au)	Embossed Tape 2 000 pcs/reel	(UL, CSA approved)	
PS9313L2	PS9313L2-AX		20 pcs (Tape 20 pcs cut)		PS9313L2
PS9313L2-E3	PS9313L2-E3-AX		Embossed Tape 2 000 pcs/reel		
PS9313L-V	PS9313L-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	PS9313L
PS9313L-V-E3	PS9313L-V-E3-AX		Embossed Tape 2 000 pcs/reel	(VDE0884 Part2)	
PS9313L2-V	PS9313L2-V-AX		20 pcs (Tape 20 pcs cut)	Approved (Option)	PS9313L2
PS9313L2-V-E3	PS9313L2-V-E3-AX		Embossed Tape 2 000 pcs/reel		

\*1 For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current <sup>*1</sup>	lf	25	mA
	Reverse Voltage	VR	5	V
Detector	Supply Voltage	Vcc	–0.5 to +35	V
	Output Voltage	Vo	–0.5 to +35	V
	Output Current	lo	15	mA
	Power Dissipation <sup>*2</sup>	Pc	100	mW
Isolation	Voltage <sup>*3</sup>	BV	5 000	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +110	°C
Storage Temperature		Tstg	-55 to +125	°C

- \*1 Reduced to 0.3 mA/°C at  $T_{\text{A}}$  = 70°C or more.
- \*2 Reduced to 2.0 mW/°C at  $T_A = 75^{\circ}C$  or more.
- \*3 AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

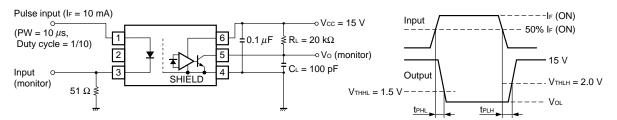
#### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	4.5	15	30	V
Output Voltage	Vo	0		30	V
Forward Current (ON)	IF (ON)	8		12	mA
Forward Voltage (OFF)	VF (OFF)	0		0.8	V

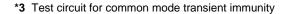
	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	I⊧ = 10 mA, T₄ = 25°C	1.2	1.56	1.9	V
	Reverse Current	Ir	Vr = 3 V, Ta = 25°C			10	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	Low Level Output Voltage	Vol	I⊧ = 10 mA, Io∟ = 2.4 mA		0.13	0.6	V
	High Level Output Current	Іон	Vcc = 30 V, VF = 0.8 V		1.0	50	μA
	High Level Supply Current	Іссн	$V_{CC} = 30 \text{ V}, \text{ V}_F = 0.8 \text{ V}, \text{ V}_O = \text{open}$		0.6	1.3	mA
	Low Level Supply Current	lcc∟	Vcc = 30 V, I⊧ = 10 mA, Vo = open		0.7	1.3	mA
Coupled	Threshold Input Current $(H \rightarrow L)$	Ifhl	Vo = 0.8 V, Io = 0.75 mA		0.75	5.0	mA
	Current Transfer Ratio (Ic/IF)	CTR	I⊧ = 10 mA, Vo = 0.6 V	44	110		%
	Isolation Resistance	Ri-o	VI-0 = 1 kVDC	10 <sup>11</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.7		pF
	Propagation Delay Time $(H \rightarrow L)^{2}$	tрнL	$\label{eq:ls} \begin{split} I_{\text{F}} &= 10 \text{ mA},  R_{\text{L}} = 20 \; \text{k}\Omega,  C_{\text{L}} = 100 \; \text{pF}, \\ V_{\text{THHL}} &= 1.5 \; \text{V},  \text{V}_{\text{THLH}} = 2.0 \; \text{V} \end{split}$		240	500	ns
	Propagation Delay Time $(L \rightarrow H)^{2}$	tрін			460	750	
	Maximum Propagation Delays	tplн—tpнl		-200	220	650	
	Pulse Width Distortion (PWD)	tphl—tplh			220	650	
	Common Mode Transient Immunity at High Level Output <sup>*3</sup>	СМн	$ \begin{array}{l} T_{\text{A}} = 25^{\circ}\text{C}, \ \text{I}_{\text{F}} = 0 \ \text{mA}, \ \text{Vo} > 3.0 \ \text{V}, \\ V_{\text{CM}} = 1.5 \ \text{kV}, \ \text{R}_{\text{L}} = 20 \ \text{k}\Omega, \\ C_{\text{L}} = 100 \ \text{pF} \end{array} $	15			kV/με
	Common Mode Transient Immunity at Low Level Output <sup>*3</sup>	CM∟	$ \begin{array}{l} T_{\text{A}} = 25^{\circ}\text{C}, \ \text{I}_{\text{F}} = 10 \ \text{mA}, \ \text{Vo} < 1.0 \ \text{V}, \\ V_{\text{CM}} = 1.5 \ \text{kV}, \ \text{R}_{\text{L}} = 20 \ \text{k}\Omega, \\ C_{\text{L}} = 100 \ \text{pF} \end{array} $	15			kV/µs

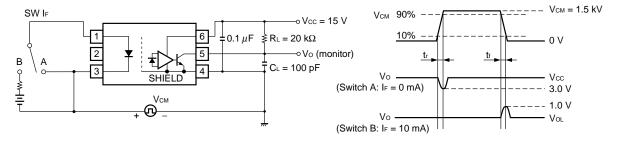
## <R> ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = -40 to +110°C, Vcc = 15 V, unless otherwise specified)

- \*1 Typical values at  $T_A = 25^{\circ}C$ .
- \*2 Test circuit for propagation delay time



Remark CL includes probe and stray wiring capacitance.





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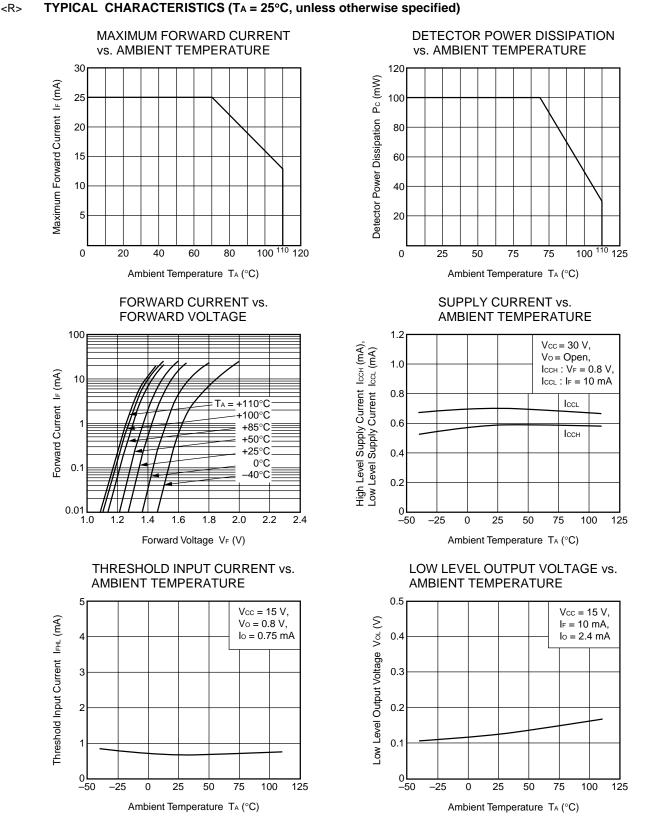
#### **USAGE CAUTIONS**

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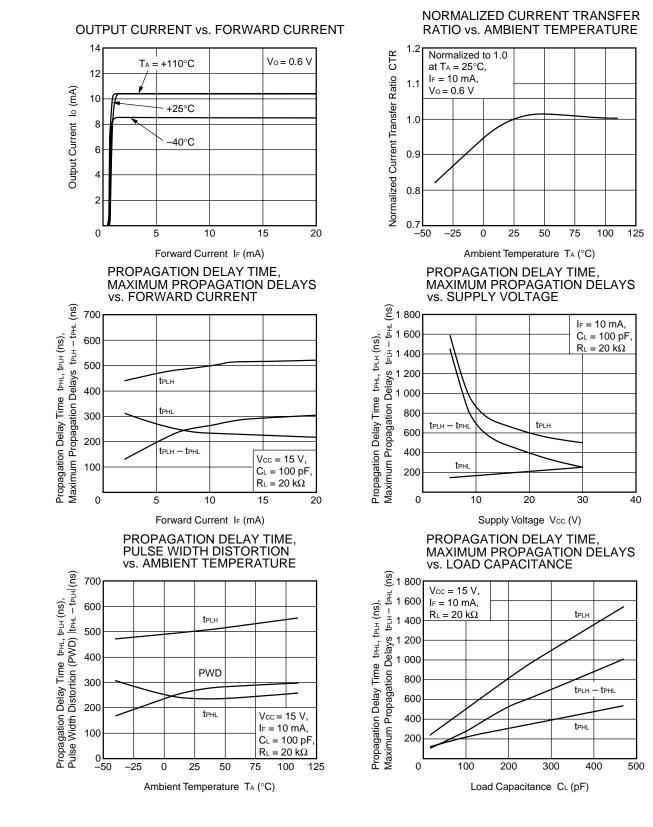
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μF is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Pin 2 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

\*1 NC: Not connected (No connection)

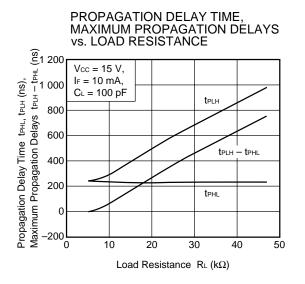
4. Avoid storage at a high temperature and high humidity.



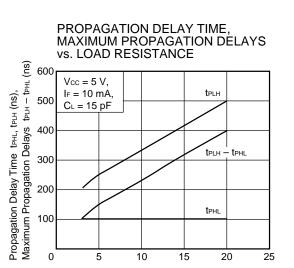
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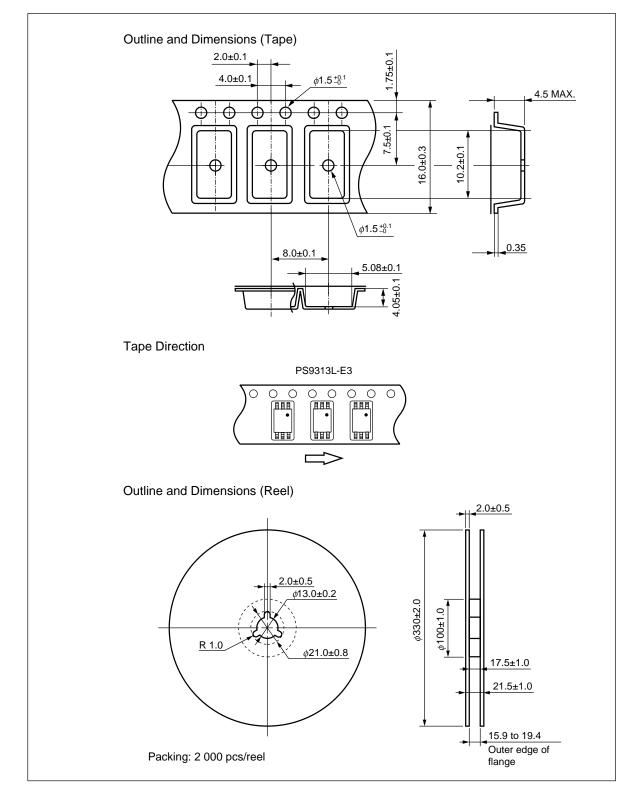


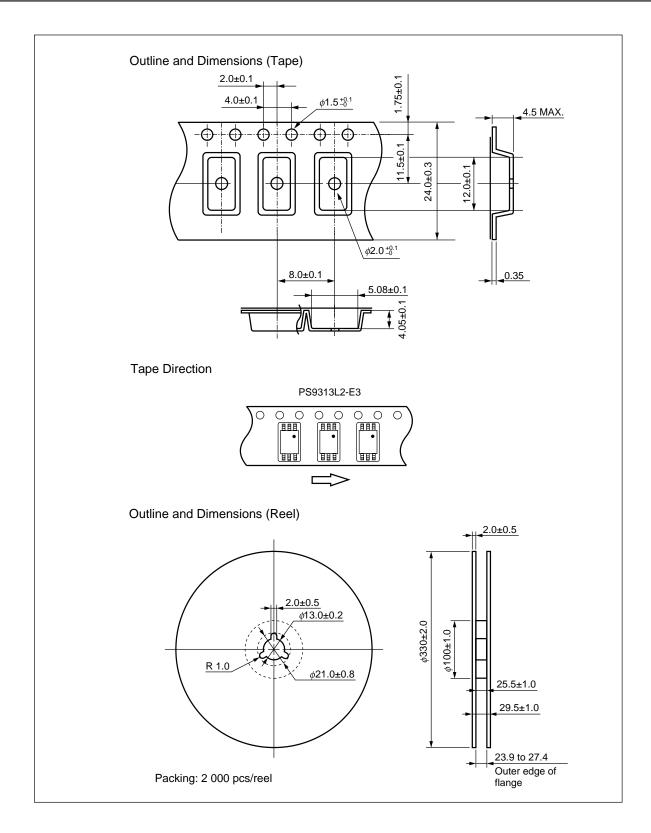
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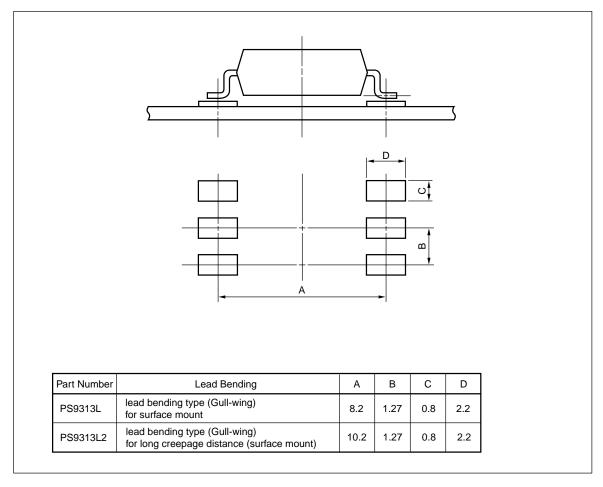
Load Resistance RL (kΩ)

## <R> TAPING SPECIFICATIONS (UNIT: mm)





## <R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



#### <R> NOTES ON HANDLING

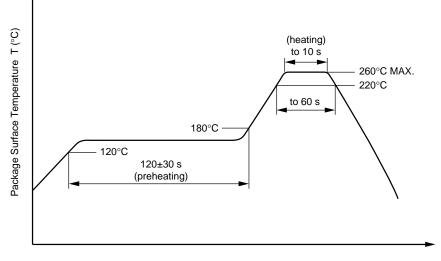
#### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to  $180^\circ\text{C}$
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by soldering iron

Peak temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

#### (4) Cautions

#### • Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

## <R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 pC$	Uiorm Upr	1 130 1 695	V <sub>peak</sub> V <sub>peak</sub>
Test voltage (partial discharge test, procedure b for all devices) $U_{\text{Pr}}$ = 1.875 $\times$ U $_{\text{IORM}},$ $P_{\text{d}}$ $<$ 5 pC	Upr	2 119	Vpeak
Highest permissible overvoltage	Utr	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		lll a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +110	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 <sup>12</sup> 10 <sup>11</sup>	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation) Isolation resistance	Tsi Isi Psi	175 400 700	°C mA mW
V <sub>I0</sub> = 500 V dc at T <sub>A</sub> = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

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	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or i any way allow it to enter the mouth.